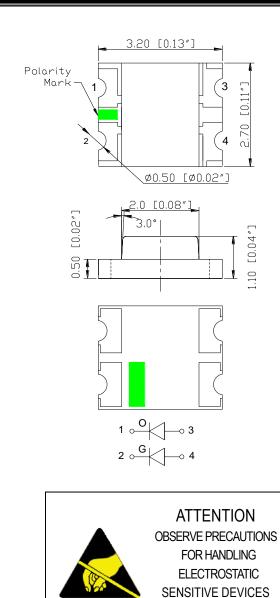
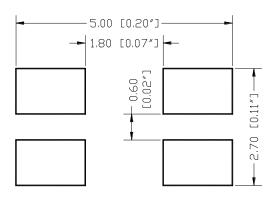
3155 Series SMD Chip LED Lamps

Part Number: N0D17S93

Package outlines



RECOMMEND PAD LAYOUT



I	TEM	MATERIALS		
Resin (mold)		Ероху		
Lens color		Water transparent		
Dice	Orange	AlGaInP		
DICC	Green	AlGaInP		

NOTES:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are $\pm 0.1 \text{mm}$ (0.004inch) unless otherwise noted.

Rev :	ev : Date Drawn by :		Checked by :	Approved by :	
A	2011/11/30	李梅英	許媚鳳	黄靜文	

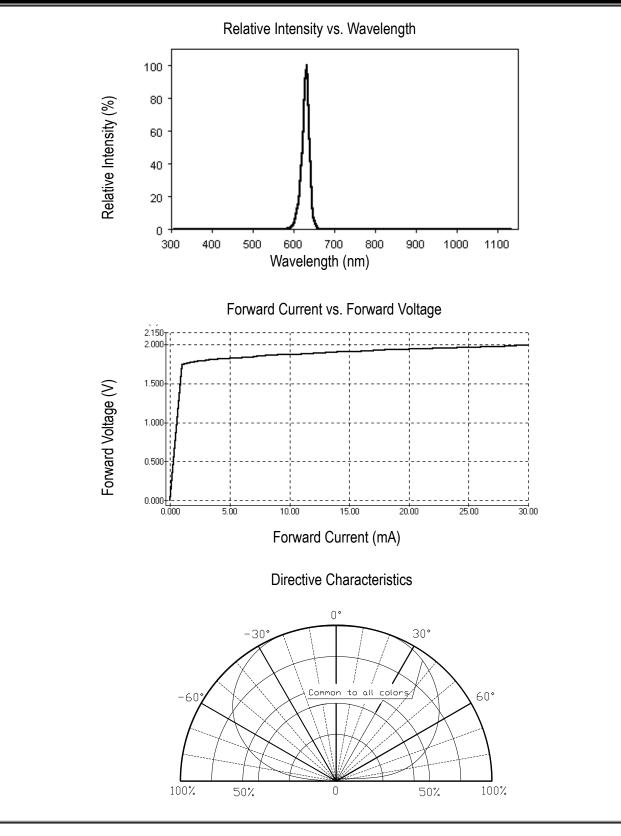
Part Number: N0D17S93

Absolute maximum ratings (T _A =25°C					
Parameter		Symbol	Vá	Unit	
i didileter		Cymoor	0	G	<u> </u>
Power dissipation		Pd	75	75	mW
Forward current	lf	30		mA	
Reverse voltage		Vr	5		V
Operating temperature range		Тор	-40 ~+80		°C
Storage temperature range		Tstg	-40 ~+85		°C
Peak pulsing current (1/8 duty f=1kHz)		lfp	125		mA
Electro-optical characteristics				(T _A =2	25°C)
Demonster	Test	Symbol	Value		
Parameter	Condition	Symbol	NA: 7	M	Unit

	Test Symbol		Value				
Parameter	Condition	Symbol		Min	Тур	Max	Unit
Wavelength at peak emission	lf=20mA	λpeak	O G		630 572		nm
Spectral half bandwidth	lf=20mA	$ riangle \lambda$	O G		18 16		nm
Dominant wavelength	lf=20mA	λdom	O G	615 565	625 570	630 576	nm
Forward voltage	lf=20mA	Vf	O G	1.7 1.7	2.0 2.0	2.5 2.5	V
Luminous intensity	lf=20mA	lv	O G	80 32	160 55	250 100	mcd
Viewing angle at 50% lv	lf=10mA	201/2			140		Deg
Reverse current	Vr=5V	lr				10	μΑ

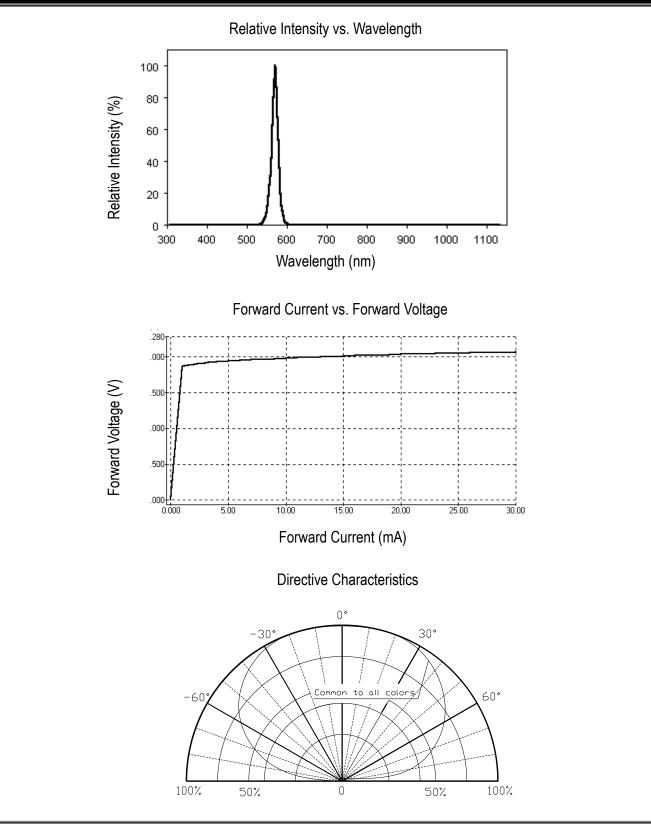
Part Number: N0D17S93

OPTICAL CHARACTERISTIC CURVES (Orange)



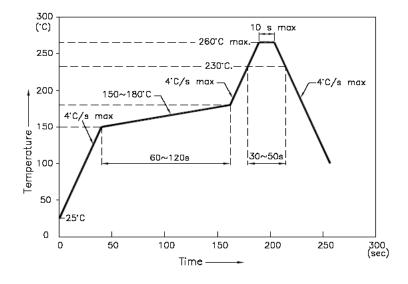
Part Number: N0D17S93

OPTICAL CHARACTERISTIC CURVES (Green)



Reflow Profile

Reflow Temp/Time



NOTES:

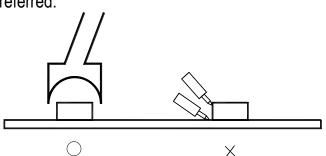
- 1. We recommend the reflow temperature 245 °C (±5 °C).the maximum soldering temperature should be limited to 260 °C.
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is \leq 5sec when 260°C. If temperature is higher, time should be shorter (+10°C \rightarrow -1sec).Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C .

Rework

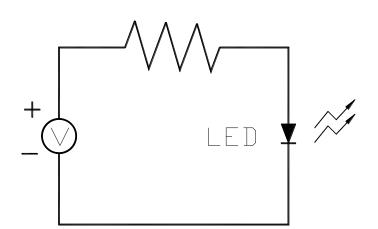
- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

Test circuit



Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.Storage

2.1 It is recommended to store the products in the following conditions: Humidity: 60% R.H. Max.

Temperature : 5°C~30°C(41°F~86°F)

2.2 Shelf life in sealed bag: 12 month at < 5°C~30°C and < 30% R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at ≤20 R.H. with zip-lock sealed.

3.Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

3.1 60 \pm 3°C x(12~24hrs) and < 5%RH, taped reel type

 $3.2\ 100\pm3^\circ\text{C}\ x(45\text{min}\sim1\text{hr})$, bulk type

3.3 130±3°C x(15~30min), bulk type

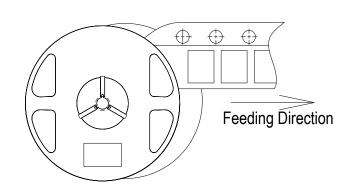
Test items and results of reliability

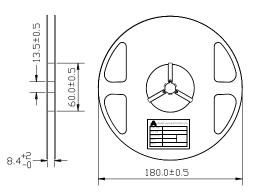
Туре	Test Item	Test Item Test Conditions		Number of Damaged
	Temperature Cycle	-20°⊂ 30min ↑↓ 80°⊂ 30min	100 cycle	0/22
	Thermal Shock	-20°⊂ 15min ↑↓ 80°⊂ 15min	100 cycle	0/22
Environmental Sequence	High Humidity Heat Cycle	30°C⇔ 65°C 90%RH 24hrs/1cycle	10 cycle	0/22
Envi Se	High Temperature Storage	ure Storage T _a =80°C		0/22
	Humidity Heat Storage	Ta=60°⊂ RH=90%	1000 hrs	0/22
	Low Temperature Storage	Ta=-30°⊂	1000 hrs	0/22
	Life Test	Ta=25°⊂ I _F =20mA	1000 hrs	0/22
Operation Sequence	High Humidity Heat Life Test	60°⊂ RH=90% I _F =10mA	500 hrs	0/22
	Low Temperature Life Test T _a =-20°C I _F =20mA		1000 hrs	0/22

3155 Series SMD Chip LED Lamps Packaging Specifications

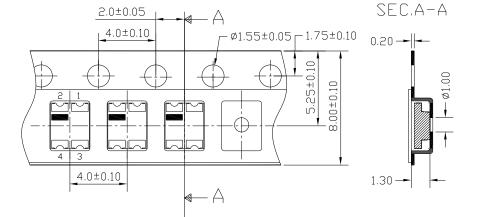
• Feeding Direction

• Dimensions of Reel (Unit: mm)

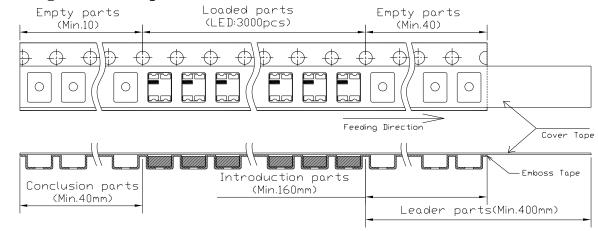




• Dimensions of Tape (Unit: mm)



• Arrangement of Tape

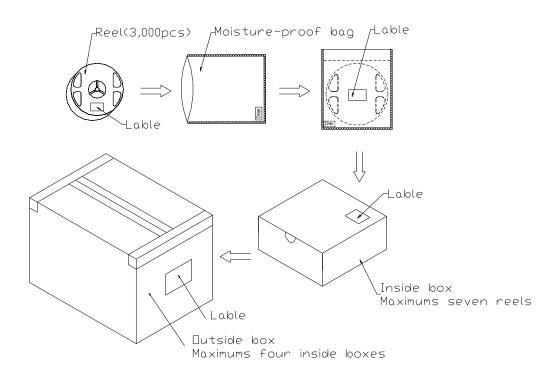


NOTES

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The polarity mark is oriented towards the tape sprocket hole ;
- 4. 3,000pcs/Reel.

3155 Series SMD Chip LED Lamps Packaging Specifications

Packaging specifications



NOTES:

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 21,000pcs) packed in an inside box (size: about 238mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the root bag, part No. And quantity should appear on the label on the steps.

SURF	ACE M	IOUNI	T LED LAN	MPS			
Part Nu	mber: N()D17S93					
Forwar	d Voltage	e Rank C	combination (IF=20mA)			
Ra	nk		Min.		Max.	Unit	
Orange			1.7		2.5		
Green			1.7		2.5	- V	
Lumino	ous Inten	sity Ran	k Combinatio	on (IF=20mA)			
Ra	nk		Min.		Max.	Unit	
	I 80 100		100				
	J		100		125	_	
Orange	K		125		160	_	
	L		<u>160</u> 200		200 250	-	
	E		32		40	mcd	
	F		40		50	_	
Green	G		50		63	-	
	Н		63		80		
			80		100		
Domina	ant wavel	ength R	ank Combina	tion (IF=20m	A)		
Ra	nk		Min.		Max.	Unit	
	S		615		620		
Orange	t		620		625		
	u		625		630	nm	
0	h		565		568		
Green i			568 572		<u> </u>		
Group	Name on	Label		DATA: □Lt	□Gi 20)		
DATA: Oran]Lt □(Gi 20	Vf(V)	lv (mcd)	λd (nm)	Test Condition	
Orange	□→L·	→t→20	1.7~2.5	160~200	620~625	IE-00 A	
Green □→G→i→20		→ i→20	1.7~2.5	50~63	568~572	IF=20mA	

* NOTE:

- 1. The tolerance of luminous intensity (Iv)is $~\pm 15\,\%$.
- 2. The tolerance of dominant wavelength is ± 1 nm.
- 3. This specification is preliminary.